

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Yun-Hyeok IM, et al.

Serial No.: 10/776,680 Examiner: LjiljanaV. Ciric

Filed: February 10, 2004 Group Art Unit: 3744

Confirmation No.: 3786

For: CLOTHESPIN TYPE HEAT DISSIPATING APPARATUS FOR  
SEMICONDUCTOR MODULE

Date: September 5, 2007

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Responsive to the Office Action, Paper No. 20070524, dated June 5, 2007, please amend the application as follows.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Drawings** begin on page 3 and include replacement and annotated sheets.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 4 of this paper.

**Remarks/Arguments** begin on page 10 of this paper.